	Material Composit © Copyright 2005. IPC, International and Pan-Am	Bannockb	urn, Illinois, A	ll rights reserved untions.	under both le	This docume evel parts, t	ent is a decla he declaratio	ration of th n encomp	he substances basses all low	s within the manufactur er level materials for w	er listed	item. Note: if manufacturer	the item is an a has engineering	ssembly with lower responsibility.
1752-21.1					Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				als and Mfg Information				
Supplier I	Information													
Company na	ame*	Company unique ID			Unique ID Authority				Response Date*					
onsemi											2024-05-05			
Contact Nan	ne	Title - Contact				Phone - Contact*				Email - Contact*				
Product-En	v-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized 1	Representative*	Title - Representative			Phone - Representative*			Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com					
F	Requester Item Number	Mfr Item	Number Mfr Item Name				Effective D	ate Vers	e Version Manufacturing			Weight*	UOM	Unit Type
	LB11852FV		V-W-AH 1PH PRE SENSOR CLOSE ; Single phase pre-driver with hall sensor method (closed loop speed control)				2024-05-05			РНМ		80.0	mg	Each
Manufact	uring Proccess Information	1												
Т	erminal Plating / Grid Array Materia	al T	Cerminal Base Alloy J-STD-02		J-STD-020 MSL	Rating	Peak Process Body Temp		dy Temperatu	ature Max Time at Peak Te		Temperature Number of Reflow Cycles		cles
c	contains Bi CU Alloy			у 3			260 C 30			seconds 3				
Comments														
ATTENTIO	N: MSL 3 Rated item requires Ba	ke and D	ry Pack (after	electrical test)										
For more inf	formation regarding material com	position j	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl bhthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.76	mg	Supplier	Silicon (Si)	7440-21-3		2.7498	mg
			Supplier	Polyimide	Proprietary Data		0.0102	mg
Die Attach	0.77	mg	Supplier	Silver (Ag)	7440-22-4		0.5239	mg
			Supplier	Epoxy resins	129915-35-1		0.2227	mg
			Supplier	Other Metal Oxide	Proprietary Data		0.0168	mg
			В	Antimony Pentoxide (Sb2O5)	1314-60-9		0.0066	mg
ead Frame	25.4	mg	Supplier	Silver (Ag)	7440-22-4		0.6325	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0483	mg
			Supplier	Iron (Fe)	7439-89-6		0.6426	mg
			Supplier	Copper (Cu)	7440-50-8		24.0411	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0356	mg
Iold Compound-Black	49.58	mg		Phenolic Resin	proprietary data		2.479	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		1.3882	mg
			Supplier	Carbon Black (C)	1333-86-4		0.4958	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		1.4874	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		39.664	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		3.9664	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.0992	mg
lating	1.42	mg	В	Bismuth (Bi)	7440-69-9		0.0085	mg
			Supplier	Tin (Sn)	7440-31-5		1.4115	mg
Wire Bond - Cu	0.07	mg	Supplier	Copper (Cu)	7440-50-8		0.07	mg